Connector
Micro SIM Cover - 6 Pin

Specifications:
- Connector Type: SIM Socket
- No. of Contacts: 6
- Pitch Spacing: 2.54mm
- Contact Plating: Gold
- Contact Termination: Surface Mount Right Angle
- Row Pitch: 25.4mm
- Housing: LCP
- Voltage Current Rating: 1A, 50V AC
- Insulation Resistance: 1,000MΩ Min.
- Contact Withstanding Voltage: 500V AC for 1 minute
- Temperature Rating: -40°C to +85°C

Dimensions: Millimetres

Newark.com/multicomp-pro
Farnell.com/multicomp-pro
Element14.com/multicomp-pro
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Part Number Table

<table>
<thead>
<tr>
<th>Description</th>
<th>Part Number</th>
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<tbody>
<tr>
<td>Connector, Micro SIM, 6 Pin, Cover</td>
<td>SIMMP-00601B201-G</td>
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